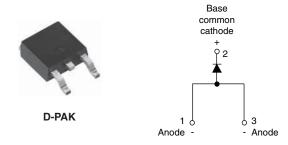


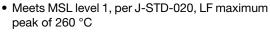
Vishay Semiconductors

## Surface Mountable Fast Soft Recovery Diode, 8 A

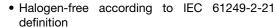


PRODUCT SUMMARY					
Package	D-PAK (TO-252AA)				
I <sub>F(AV)</sub>	8 A				
V <sub>R</sub>	200 V, 400 V, 600 V				
V <sub>F</sub> at I <sub>F</sub>	1.2 V				
I <sub>FSM</sub>	120 A				
t <sub>rr</sub>	55 ns				
Diode variation	Single die				
Snap	0.5				

### **FEATURES**











ROHS COMPLIANT HALOGEN FREE

### **APPLICATIONS**

- Output rectification and freewheeling diode in inverters, choppers and converters
- Input rectifications where severe restrictions on conducted EMI should be met

### **DESCRIPTION**

The VS-8EWF..S-M3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time, low forward voltage drop and low leakage current.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL	CHARACTERISTICS	VALUES	UNITS				
I <sub>F(AV)</sub>	Sinusoidal waveform	8	А				
V <sub>RRM</sub>		200 to 600	V				
I <sub>FSM</sub>		120	Α				
V <sub>F</sub>	8 A, T <sub>J</sub> = 25 °C	1.2	V				
t <sub>rr</sub>	1 A, 100 A/µs	55	ns				
T <sub>J</sub>	Range	- 40 to 150	°C				

VOLTAGE RATINGS							
PART NUMBER	V <sub>RRM</sub> , MAXIMUM PEAK REVERSE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I <sub>RRM</sub> AT 150 °C mA				
VS-8EWF02S-M3	200	300					
VS-8EWF04S-M3	400	500	3				
VS-8EWF06S-M3	600	700					

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum average forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 96 °C, 180° conduction half sine wave	8			
Maximum peak one cycle	I <sub>FSM</sub> <sup>(1)</sup>	10 ms sine pulse, rated V <sub>RRM</sub> applied	101	Α		
non-repetitive surge current	'FSM (*)	10 ms sine pulse, no voltage reapplied	120			
Maximum I <sup>2</sup> t for fusing	I <sup>2</sup> t	10 ms sine pulse, rated V <sub>RRM</sub> applied	51	A <sup>2</sup> s		
Maximum i-t for fusing	1-1	10 ms sine pulse, no voltage reapplied	72	A-5		
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	t = 0.1 ms to 10 ms, no voltage reapplied	510	A <sup>2</sup> √s		

#### Note

Document Number: 93375 Revision: 04-Apr-11

<sup>(1)</sup> Connecting one pin only.



## Surface Mountable Fast Soft Recovery Diode, 8 A



ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST COI	TEST CONDITIONS			
Maximum forward voltage drop	$V_{FM}$	8 A, T <sub>J</sub> = 25 °C	1.2	V		
Forward slope resistance	r <sub>t</sub>	T <sub>.I</sub> = 150 °C		16	mΩ	
Threshold voltage	V <sub>F(TO)</sub>	1) = 130 0	1.13	V		
Maximum reverse leakage aurrent	1	T <sub>J</sub> = 25 °C	V <sub>B</sub> = Rated V <sub>BBM</sub>	0.1	mΛ	
Maximum reverse leakage current	I <sub>RM</sub>	T <sub>J</sub> = 150 °C	VR = nated VRRM	3	mA	

RECOVERY CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> at 1 Apk 100 A/μs T <sub>J</sub> = 25 °C	55	ns	I <sub>FM</sub> t <sub>r</sub>	
		I <sub>F</sub> at 8 Apk	140		t <sub>a</sub> t <sub>b</sub>	
Reverse recovery current	I <sub>rr</sub>	25 A/µs	2.6	А	di/ dt/ Q <sub>rr</sub>	
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	0.25	μC	¥ I <sub>m</sub>	
Snap factor	S		0.5			

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 40 to 150	°C		
Soldering temperature	T <sub>S</sub>	For 10 seconds	240			
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation	2.5	°C/W		
Typical thermal resistance, junction to ambient (PCB mount)	R <sub>thJA</sub> <sup>(1)</sup>		50	C/VV		
Approximate weight			1	g		
Approximate weight			0.03	OZ.		
			8EWF	·02S		
Marking device		Case style TO-252AA (D-PAK)	8EWF	-04S		
			8EWF	-06S		

#### Note

 $<sup>^{(1)}</sup>$  When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140  $\mu m$ ) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994



Surface Mountable Fast Soft Recovery Diode, 8 A

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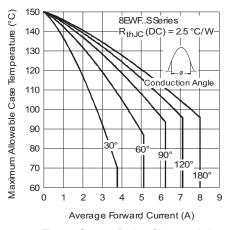


Fig. 1 - Current Rating Characteristics

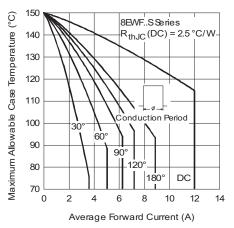


Fig. 2 - Current Rating Characteristics

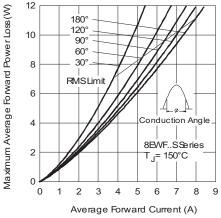


Fig. 3 - Forward Power Loss Characteristics

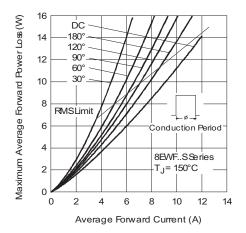
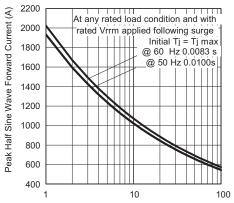


Fig. 4 - Forward Power Loss Characteristics



Number Of Equal Amplitude Half Cycle Current Pulses (N)

Fig. 5 - Maximum Non-Repetitive Surge Current

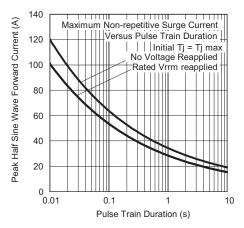


Fig. 6 - Maximum Non-Repetitive Surge Current

# Vishay Semiconductors

### Surface Mountable Fast Soft Recovery Diode, 8 A



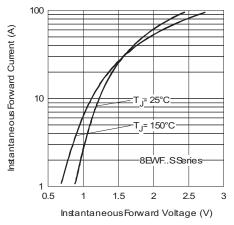


Fig. 7 - Forward Voltage Drop Characteristics

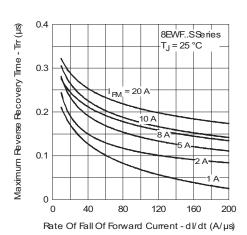


Fig. 8 - Recovery Time Characteristics, T<sub>J</sub> = 25 °C

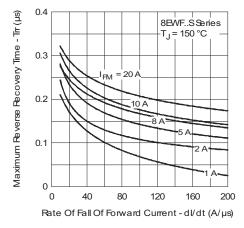


Fig. 9 - Recovery Time Characteristics, T<sub>J</sub> = 150 °C

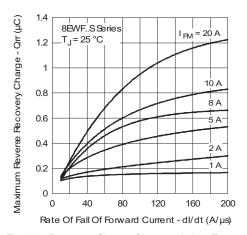


Fig. 10 - Recovery Charge Characteristics, T<sub>J</sub> = 25 °C

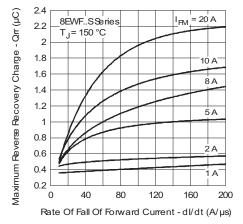


Fig. 11 - Recovery Charge Characteristics, T<sub>J</sub> = 150 °C

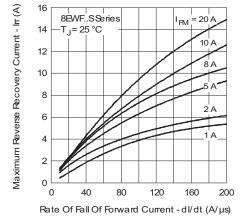


Fig. 12 - Recovery Current Characteristics, T<sub>J</sub> = 25 °C



Surface Mountable Fast Soft Recovery Diode, 8 A

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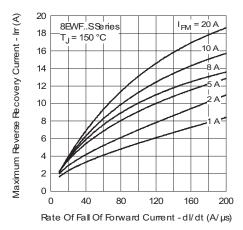


Fig. 13 - Recovery Current Characteristics, T<sub>J</sub> = 150 °C

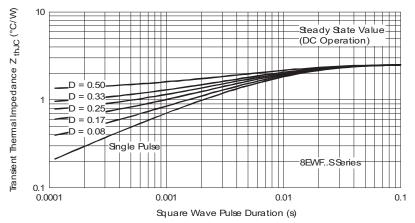


Fig. 14 - Thermal Impedance Z<sub>thJC</sub> Characteristics

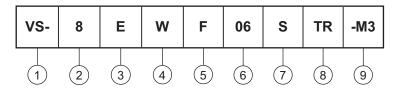
Vishay Semiconductors

Surface Mountable Fast Soft Recovery Diode, 8 A



### **ORDERING INFORMATION TABLE**

**Device code** 



- Vishay Semiconductors product
- Current rating (8 = 8 A)
- Circuit configuration:
  - E = Single diode
- 4 Package:
  - W = D-PAK
- 5 Type of silicon:
  - F = Fast soft recovery rectifier
- 02 = 200 VVoltage code x 100 = V<sub>RRM</sub> 04 = 400 V
- S = Surface mountable
- 06 = 600 V
- TR = Tape and reel
  - TRR = Tape and reel (right oriented)
  - TRL = Tape and reel (left oriented)
- 9 Environmental digit:

-M3 = Halogen-free, RoHS compliant and terminations lead (Pb)-free

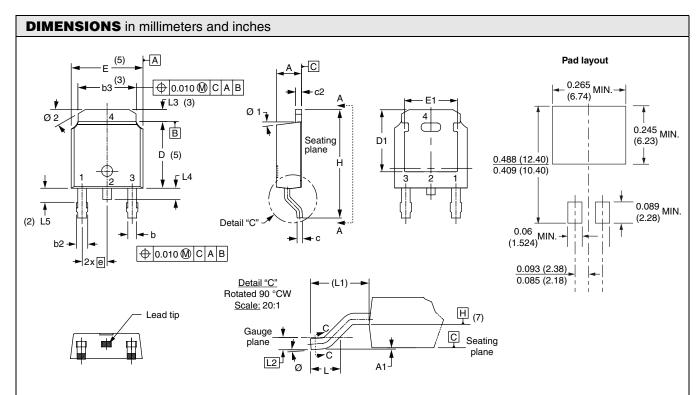
ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-8EWF02S-M3	75	3000	Antistatic plastic tubes				
VS-8EWF02STR-M3	2000	2000	13" diameter reel				
VS-8EWF02STRL-M3	3000	3000	13" diameter reel				
VS-8EWF02STRR-M3	3000	3000	13" diameter reel				
VS-8EWF04S-M3	75	3000	Antistatic plastic tubes				
VS-8EWF04STR-M3	2000	2000	13" diameter reel				
VS-8EWF04STRL-M3	3000	3000	13" diameter reel				
VS-8EWF04STRR-M3	3000	3000	13" diameter reel				
VS-8EWF06S-M3	75	3000	Antistatic plastic tubes				
VS-8EWF06STR-M3	2000	2000	13" diameter reel				
VS-8EWF06STRL-M3	3000	3000	13" diameter reel				
VS-8EWF06STRR-M3	3000	3000	13" diameter reel				

LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95016</u>					
Part marking information	www.vishay.com/doc?95176				
Packaging information	www.vishay.com/doc?95033				



## Vishay High Power Products

# **D-PAK (TO-252AA)**



SYMBOL	MILLIM	MILLIMETERS		INCHES	
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	5.21	-	0.205	1	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	MILLIM	ETERS	INC	HES	NOTES
STWIDGE	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29	BSC	0.090	BSC	
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108 REF.		
L2	0.51	0.51 BSC		0.020 BSC	
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2
Ø	0°	10°	0°	10°	
Ø1	0°	15°	0°	15°	
Ø2	25°	35°	25°	35°	

#### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- $^{(7)}$  Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC outline TO-252AA



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